



Product Change Notification

Change Notification #: 114272-00
Change Title: Intel® Edison Breakout Board Kit; Intel® Edison Compute Module; Intel® Edison Kit for Arduino* and Edison Multi-Pack PCN 114272-00, Label and Packaging

Date of Publication: December 21, 2015

Key Characteristics of the Change:

Label, Packaging

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	January 20, 2016
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Description of Change to the Customer:

The Edison packaging is being changed to incorporate Intel's latest brand design elements. The Edison shield with a printed label adhered on top is changing to a pad printed shield. Minor changes include an on pad printed shield with square around the letter R (Japan) and certification number CNC C-13956 (Argentina) added.

Intel is implementing the following changes on the Edison label and packaging

Product codes affected:

EDI2ARDUIN.AL.K Edison: Standard Power on board antenna + Arduino

EDI3ARDUIN.AL.K Edison: Standard Power on board antenna + Arduino



Figure-1: Pre-Change (Front)
Length 156", Width 87", Height 40"



Figure-2: Post-change (Front)
Length 79", Width 32", Height 135"



Figure-3: Post-change (Back)
 Length 79", Width 32", Height 135"

Product codes affected:

- | | |
|----------------|--|
| EDI2.LPON.AL.S | Edison: Low Power on board antenna |
| EDI2.SPON.AL.S | Edison: Standard Power on board antenna |
| EDI3.SPON.AL.S | Edison: Standard Power on board antenna |
| EDI2.SPOF.AL.S | Edison: Standard Power Off board antenna |
| EDI2.LPOF.AL.S | Edison: Low Power Off board antenna |



Figure-1: Pre-Change (Front)
 Length 106", Width 87", Height 40"



Figure-2: Post-Change (Front)
 Length 79", Width 32", Height 135"

Product codes affected:

EDI2BB.AL.K Edison: Standard Power on board antenna + Mini-Breakout
EDI3BB.AL.K Edison: Standard Power on board antenna + Mini-Breakout



Figure-1: Pre-Change (Front)
Length 106", Width 87", Height 40"

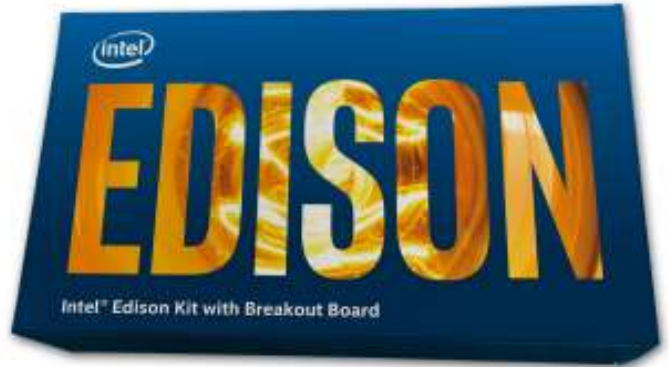


Figure-2: Post-Change (Front)
Length 79", Width 32", Height 135"



Figure-3: Post-change (Back)
Length 79", Width 32", Height 135"

Product codes affected for Label Change:

EDI2ARDUIN.AL.K	Edison: Standard Power on board antenna + Arduino
EDI3ARDUIN.AL.K	Edison: Standard Power on board antenna + Arduino
EDI2.LPON.AL.S	Edison: Low Power on board antenna
EDI2.SPON.AL.S	Edison: Standard Power on board antenna
EDI3.SPON.AL.S	Edison: Standard Power on board antenna
EDI2.SPOF.AL.S	Edison: Standard Power Off board antenna
EDI2.LPOF.AL.S	Edison: Low Power Off board antenna
EDI2BB.AL.K	Edison: Standard Power on board antenna + Mini-Breakout
EDI3BB.AL.K	Edison: Standard Power on board antenna + Mini-Breakout
EDI2.SPON.AL.MP	Edison Multi-Pack: Standard Power on board antenna
EDI2.SPOF.AL.MP	Edison Multi-Pack: Standard Power Off board antenna
EDI2.LPON.AL.MP	Edison Multi-Pack: Low Power on board antenna
EDI2.LPOF.AL.MP	Edison Multi-Pack: Low Power Off board antenna

Label Change



Current – Shield w/ printed label on top (sticker)



New – Print on the shield directly (no sticker)

Customer Impact of Change and Recommended Action:

Customers may continue to receive both box and label types until current inventory is depleted.

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your Intel Field Sales Representative with any questions, requests or concerns.

Products Affected / Intel Ordering Codes:

Product Code	MM#
EDI2.SPON.AL.S	939910
EDI2.SPOF.AL.S	939957
EDI2.LPON.AL.S	939962
EDI2.LPOF.AL.S	939975
EDI2ARDUIN.AL.K	939976
EDI2BB.AL.K	939977
EDI3.SPON.AL.S	939993
EDI3ARDUIN.AL.K	939997
EDI3BB.AL.K	939998
EDI2.SPON.AL.MP	939978
EDI2.SPOF.AL.MP	939983
EDI2.LPON.AL.MP	939985
EDI2.LPOF.AL.MP	939988

PCN Revision History:

Date of Revision:

December 21, 2015

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

#114272 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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